



Part Number : 714362364

Product Description : 1.00mm Mezz (IEEE 1386) Plug, Surface Mount, Dual Row, Vertical Stacking, 64 Circuits, 8.35mm Unmated Height, with PCB Locator Pegs, with Robotic Placement Metal Cap, 0.76µm Gold (Au) Selective Plating, Tube Pac

Status : Active

Series Number : 71436

Product Category : Board-to-Board Connectors

Documents & Resources

Drawings

- Drawing 714362364_sd.pdf
- Packaging Design Drawing PK-70873-0607-001.pdf
- Packaging Design Drawing PK-70873-063-001.pdf

3D Models and Design Files


- 3D Model 714362364_stp.zip

Specifications

- Product Specification PS-71436-9999-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)8585-DC (23 Jan 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Board-to-Board Connectors
Series	71436
Description	1.00mm Mezz (IEEE 1386) Plug, Surface Mount, Dual Row, Vertical Stacking, 64 Circuits, 8.35mm Unmated Height, with PCB Locator Pegs, with Robotic Placement Metal Cap, 0.76µm Gold (Au) Selective Plating, Tube Pac
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Family	1.00mm Mezzanine (IEEE 1386)
Product Name	1.00mm Mezzanine (IEEE 1386)
UPC	800753784697

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	100V

Physical

Breakaway	No
Circuits (Loaded)	64
Circuits (maximum)	64
Color - Resin	Natural
Flammability	94V-0

Glow-Wire Capable	No
Lock to Mating Part	None
Mated Height	10.00mm, 12.00mm, 13.00mm, 15.00mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.402/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	None
PCB Thickness - Recommended	1.00mm
Pitch - Mating Interface	1.00mm
Plating min - Mating	0.762µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Lead-Free Process Capability	REFLOW
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
1.00mm Mezz (IEEE 1386) Vertical Receptacles	<u>71439</u>
